

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YU-HSIEN CHOU	10/12/2022
CHI-SAN CHEN	10/12/2022
HENG-YI TSAI	10/12/2022
RECEIVING PARTY DATA	
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State/Country:	TAIWAN
Postal Code:	310401
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17994590
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NAME OF SUBMITTER:	PHILLIP R. TASHJIAN
SIGNATURE:	/Phillip R. Tashjian/
DATE SIGNED:	11/29/2022
Total Attachments: 1	
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ASSIGNMENT

WHEREAS, Yu-Hsien CHOU, Chi-San CHEN and Heng-Yi TSAI hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: Aluminum alloy material, aluminum alloy object and method for manufacturing the same
Filed: November 28, 2022 Serial No. 17/994,590
Executed on: October 12, 2022

WHEREAS, INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE of 195, Sec. 4, Chung Hsing Rd., Chutung, Hsinchu, 310401, Taiwan, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, and the entire rights, title and interest in and to any and all foreign patents and applications for any invention described in said U.S. patent applications, in any and all countries foreign to the U.S., including all rights of priority arising from them, and all the rights and privileges under any and all forms of protection, including patents, that may be granted in said countries foreign to the U.S. for them, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

2022.10.12 Yu-Hsien CHOU
Date Name: Yu-Hsien CHOU

2022.10.12 Chi-San CHEN
Date Name: Chi-San CHEN

2022.10.12 Heng-Yi TSAI
Date Name: Heng-Yi TSAI